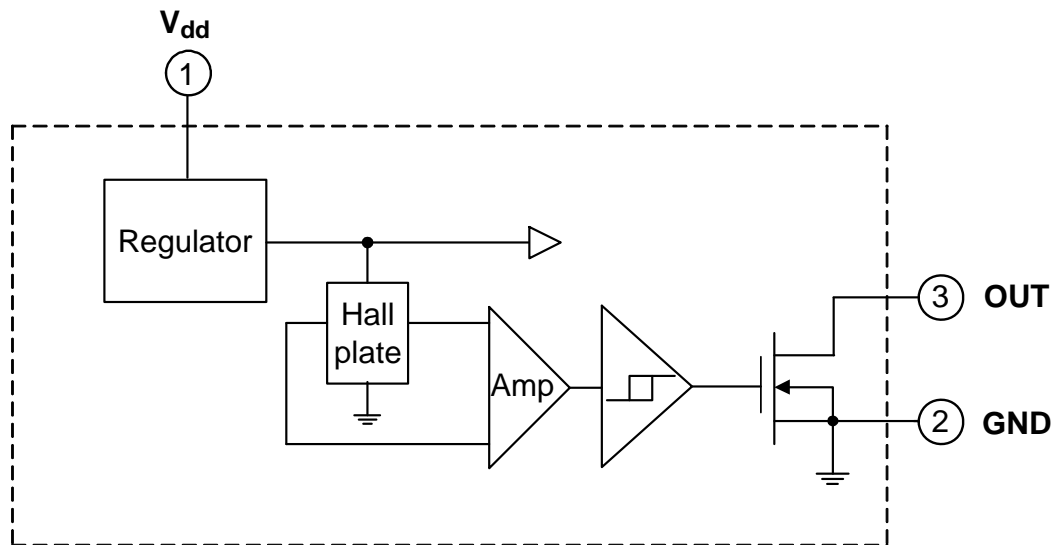


Pin Descriptions

Pin Name	P/I/O	Pin #	Description
Vdd	P	1	Positive Power Supply
GND	P	2	Ground
OUT	O	3	Output Pin

Functional Block Diagram



Absolute Maximum Ratings ($T_A = 25^\circ\text{C}$)

Symbol	Characteristics		Values	Unit
Vdd	Supply Voltage		30	V
B	Magnetic Flux Density		Unlimited	
V _{DS}	Output OFF Voltage		30	V
I _d	Output "ON" Current	Continuous	25	mA
T _s	Storage Temperature Range		-65~+150	°C
T _{J(MAX)}	Maximum Junction Temperature		150	°C
P _D	Package Power Dissipation	SIP-3L	550	mW
		SC59	230	mW

Recommended Operating Conditions

Symbol	Parameter	Conditions	Min	Max	Unit
Vdd	Supply Voltage (Note 2)	Operating	4.2	28	V
T _A	Operating Ambient Temperature	Operating	-40	125	°C

Notes: 2. The output of IC will be switched after the supply voltage is over 4.2V, but the magnetic characteristics won't be normal until the supply is over 4.5V.

Electrical Characteristics ($T_A = 25^\circ\text{C}$, $V_{DD} = 12\text{V}$)

Symbol	Characteristic	Test Conditions	Min	Typ.	Max	Unit
$V_{DS(SAT)}$	Output Saturation Voltage	$I_{out} = 10\text{mA}$, $B > B_{op}$	-	300	400	mV
I_{off}	Output Leakage Current	$B < B_{rp}$	-	< 0.1	10	μA
I_{DD}	Supply Current	Output Open	-	2	4	mA

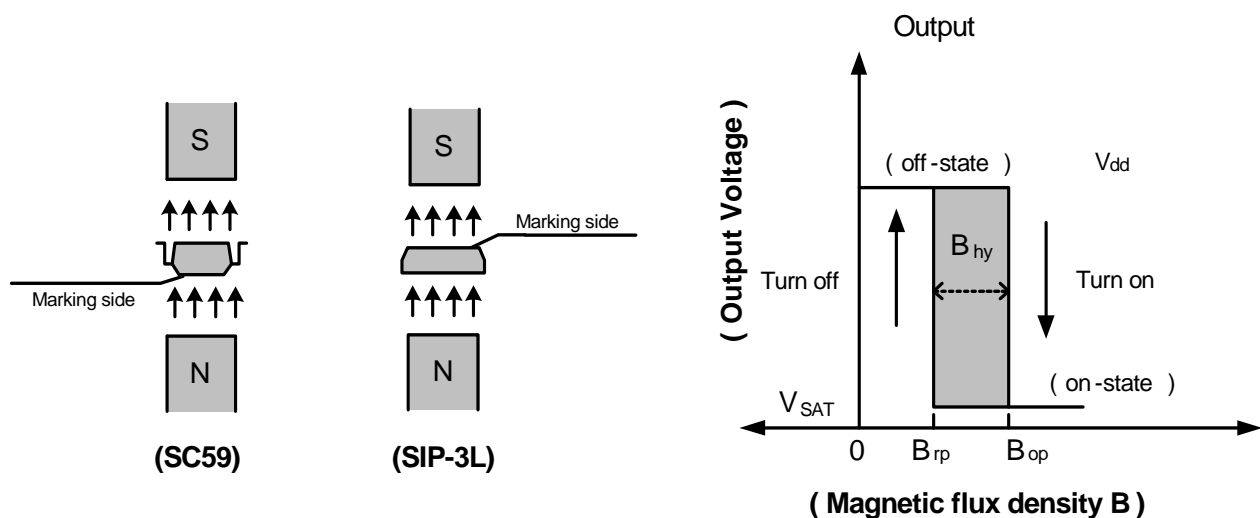
Magnetic Characteristics ($T_A = 25^\circ\text{C}$, $V_{DD} = 4.5\text{V to } 28\text{V}$, Note 3)

(1mT = 10 Gauss)

Symbol	Parameter	Min	Typ.	Max	Unit
B_{ops} (south pole to brand side)	Operation Point	90	120	150	Gauss
B_{rps} (south pole to brand side)	Release Point	30	60	90	Gauss
$B_{hy}(B_{opx} - B_{rpx})$	Hysteresis	-	60	-	Gauss

Notes: 3. Magnetic characteristics may vary with supply voltage, operating temperature and after soldering.

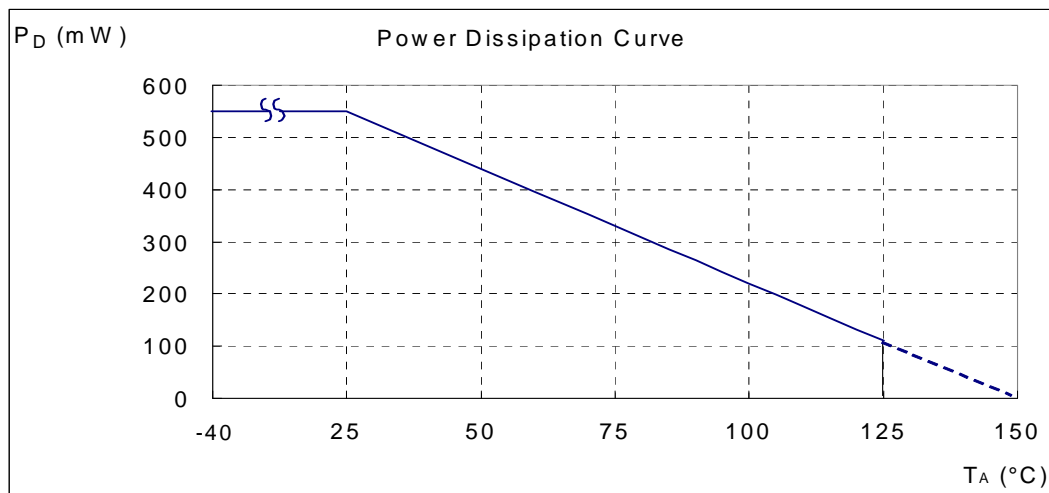
Operating Characteristics



Performance Characteristics

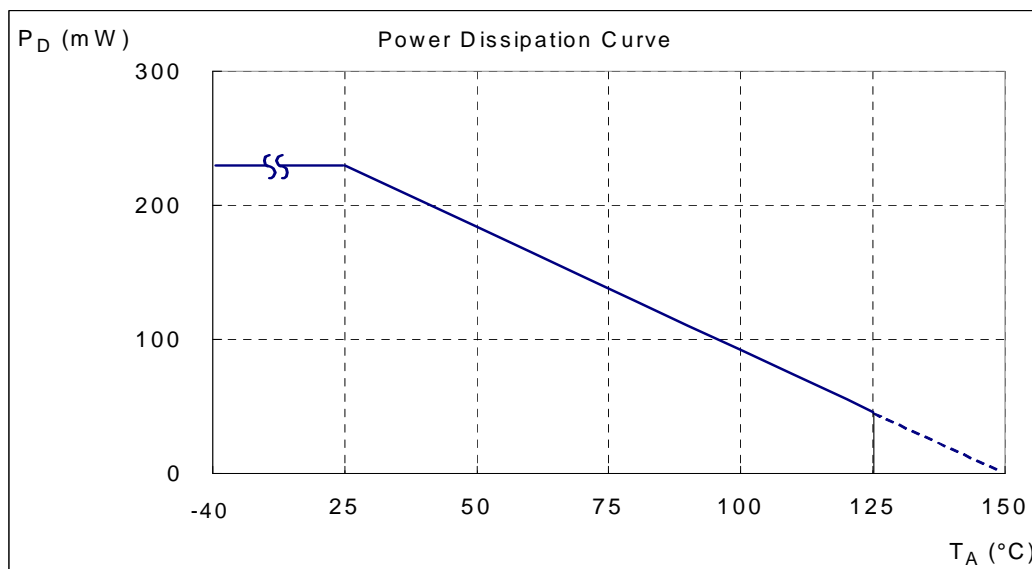
(1) SIP-3L

T _A (°C)	25	50	60	70	80	85	90	95	100
P _D (mW)	550	440	396	352	308	286	264	242	220
T _A (°C)	105	110	115	120	125	130	135	140	150
P _D (mW)	198	176	154	132	110	88	66	44	0

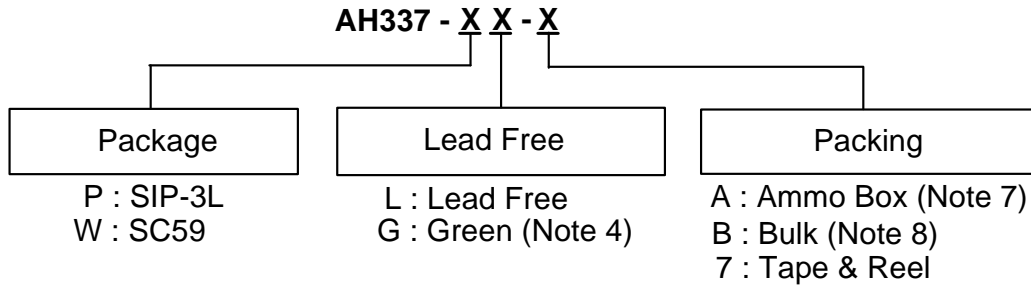








(2) SC59 (commonly known as SOT23 in Asia)

T _A (°C)	25	50	60	70	80	85	90	100	110	120	130	140	150
P _D (mW)	230	184	166	147	129	120	110	92	74	55	37	18	0



Ordering Information

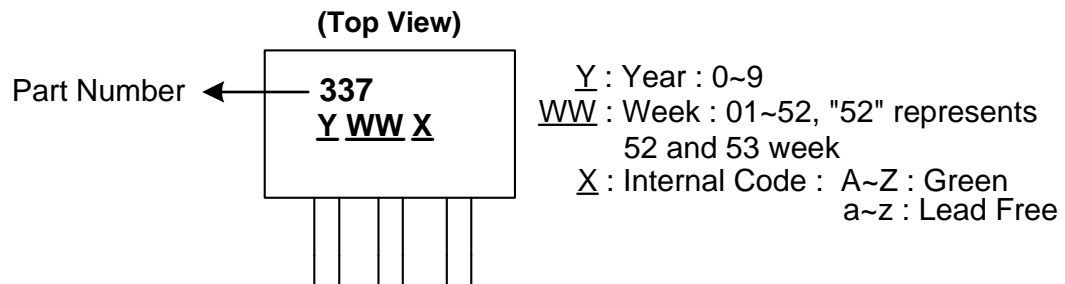


Device	Package Code	Packaging (Note 5, 6)	Bulk		7" Tape and Reel		Ammo Box	
			Quantity	Part Number Suffix	Quantity	Part Number Suffix	Quantity	Part Number Suffix
 AH337-PL-A	P	SIP-3L	NA	NA	NA	NA	4000/Box	-A
 AH337-PL-B	P	SIP-3L	1000	-B	NA	NA	NA	NA
 AH337-PG-A	P	SIP-3L	NA	NA	NA	NA	4000/Box	-A
 AH337-PG-B	P	SIP-3L	1000	-B	NA	NA	NA	NA
 AH337-WL-7	W	SC59	NA	NA	3000/Tape & Reel	-7	NA	NA
 AH337-WG-7	W	SC59	NA	NA	3000/Tape & Reel	-7	NA	NA

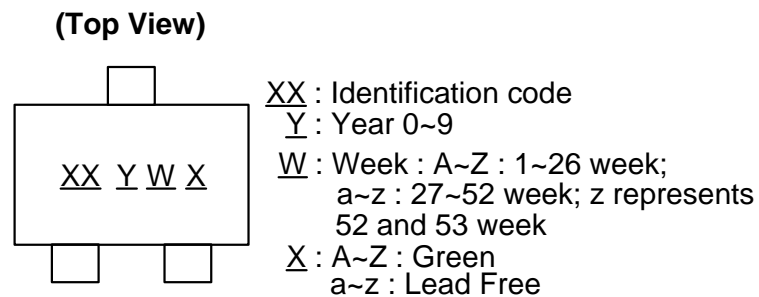
- Notes:
4. EU Directive 2002/95/EC (RoHS). All applicable RoHS exemptions applied. Please visit our website at http://www.diodes.com/products/lead_free.html.
 5. Pad layout as shown on Diodes Inc. suggested pad layout document AP02001, which can be found on our website at <http://www.diodes.com/datasheets/ap02001.pdf>.
 6. Reverse taping as shown on Diodes Inc. Surface Mount (SMD) Packaging document AP02007, which can be found on our website <http://www.diodes.com/datasheets/ap02007.pdf>.
 7. Ammo Box is for SIP-3L Spread Lead.
 8. Bulk is for SIP-3L Straight Lead.

Marking Information

(1) SIP-3L



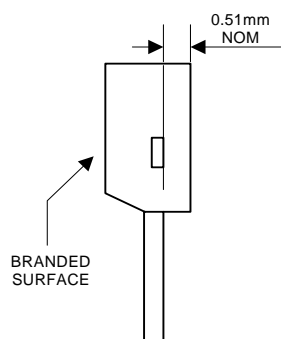
(2) SC59 (Commonly known as SOT23 in Asia)



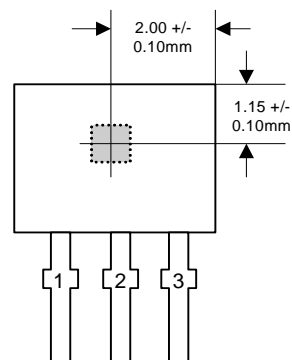
Part Number	Package	Identification Code
AH337	SC59	P1

Package Outline Dimensions (All Dimensions in mm)

(1) Package Type: SIP-3L for Bulk pack

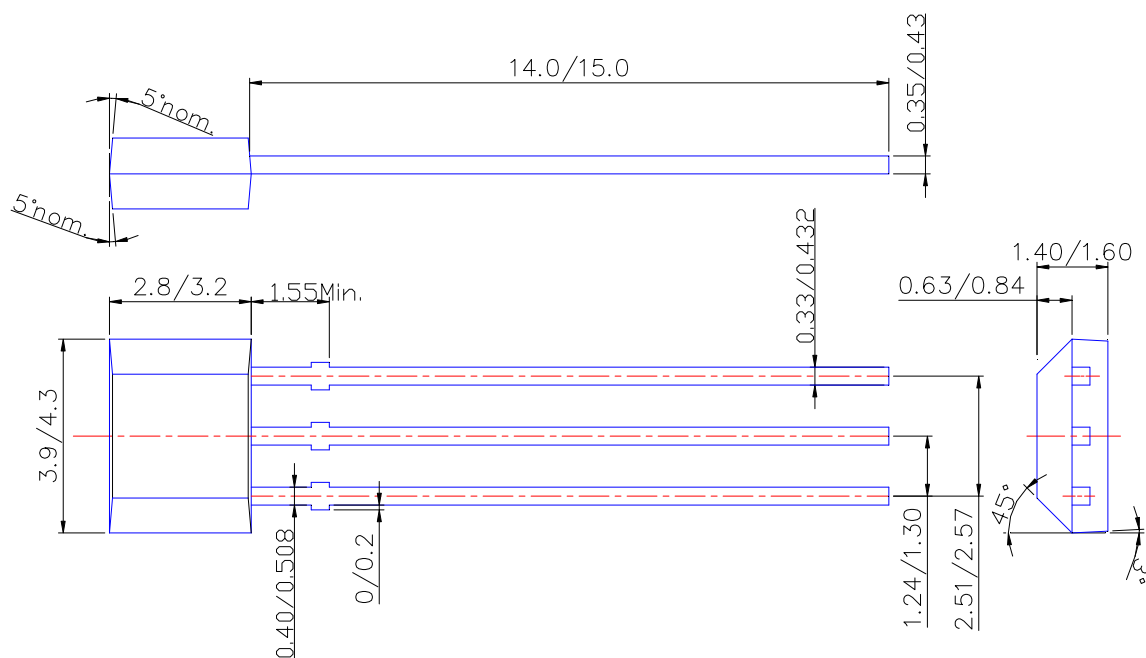


Active Area Depth



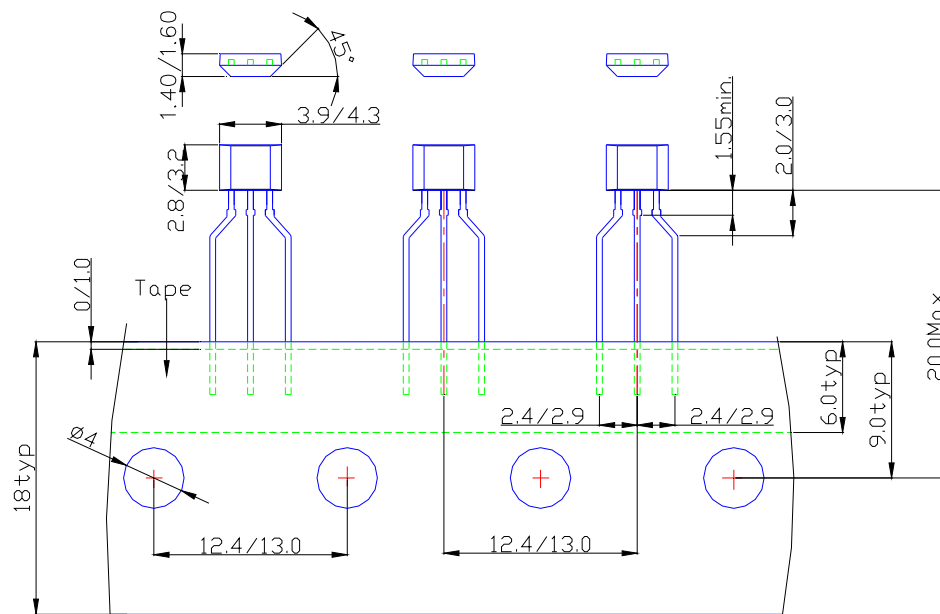
Sensor Location

Package Dimension

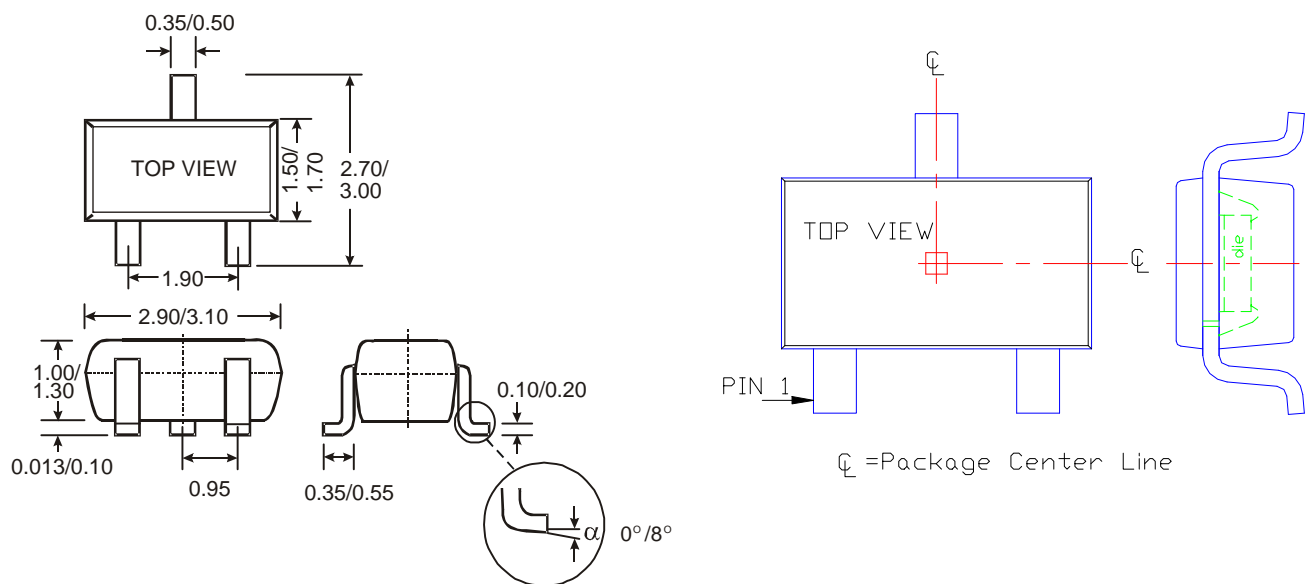


Package Outline Dimensions (Continued)

(2) Package Type: SIP-3L for Ammo pack



(3) SC59 (Commonly known as SOT23 in Asia)



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